



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of

Tsutomu SAIMOTO et al.

Application No.: 10/506,806

Filed: September 7, 2004

For: PRESSURE SENSITIVE ADHESIVE FILM FOR PROTECTION OF SEMICONDUCTOR WAFER SURFACE AND METHOD OF PROTECTING SEMICONDUCTOR WAFER WITH THE PRESSURE SENSITIVE ADHESIVE FILM

AMENDMENT AND RESPONSE TO RESTRICTION/UNITY OF INVENTION REQUIREMENT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

In response to the Office Action mailed January 3, 2006, please amend the above-identified application as follows: